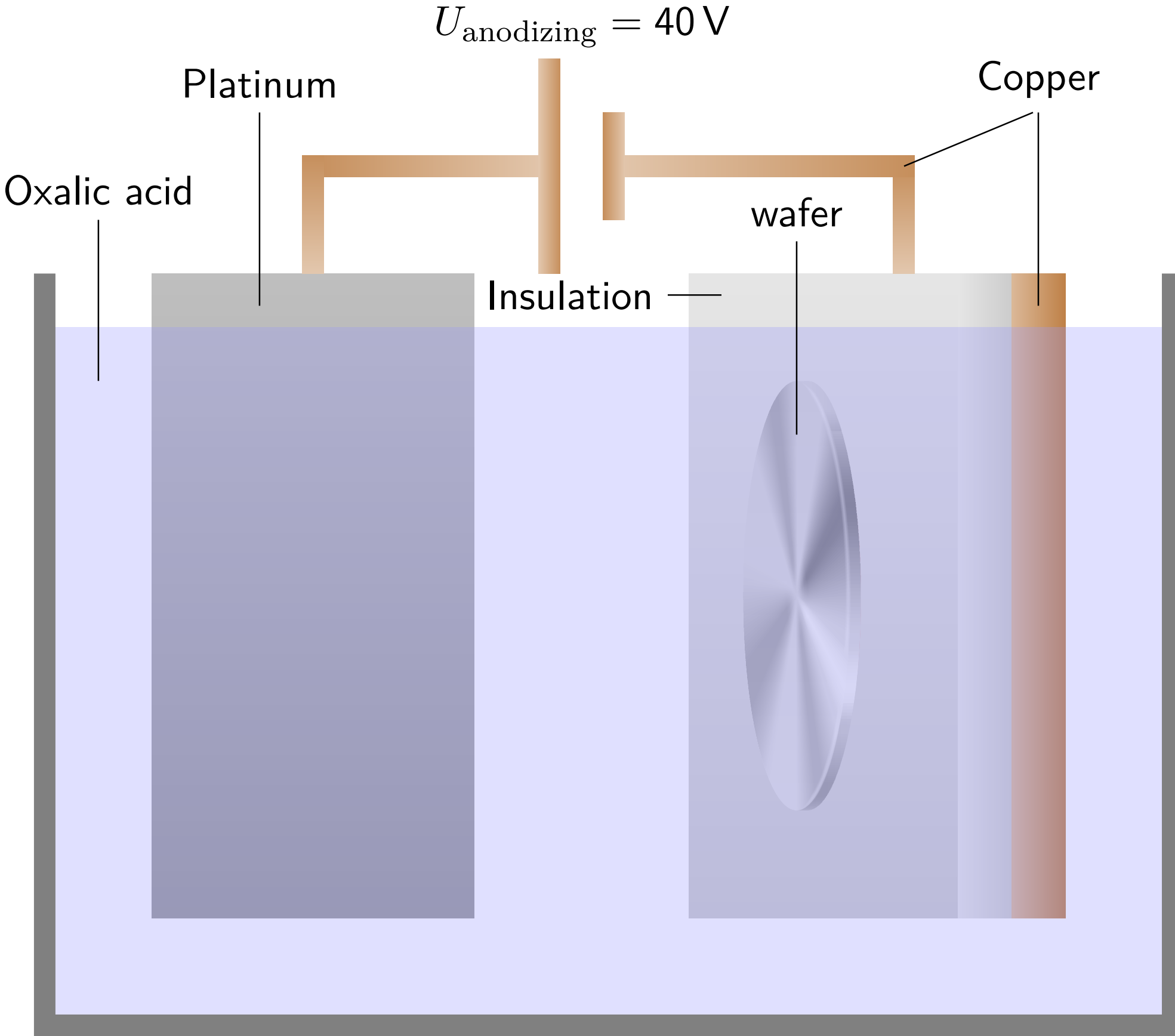
$U_{\text{anodizing}} = 40\,\text{V}$
Platinum
Copper
Oxalic acid
wafer
Insulation